

4 A Sensitive gate SCR in IPAK package



Features

- 4 A SCR
- Sensitive SCR: I_{GT} = 50 μA
- V_{DRM} / V_{RRM} = 600 V and V_{DSM} / V_{RSM} = 750 V
- 125 $^{\circ}$ C maximum junction temperature T_{j}
- IPAK package
- · Halogen-free molding, lead-free plating
- ECOPACK2 compliant

Applications

- Actuators
- Ignitors
- Inrush current limiting circuits

Product status link X0405MH

Product summary			
I _{T(RMS)} 4 A			
V _{DSM} /V _{RSM}	750 V		
I _{GT}	50 μΑ		
T _j max.	125 °C		

Description

The X04 series is 4 A SCR housed in compact through hole IPAK package. This highly sensitive device is suited to home appliances or power tools and industrial systems and drives loads up to 4 A.



1 Characteristics

Table 1. Absolute maximum ratings (limiting values)

Symbol	Parameter	Value	Unit		
I _{T(RMS)}	RMS on-state current (full sine wave)	T _c = 114 °C	4	Α	
I _{T AV}	RMS on-state average current (full sine wave)	T _c = 114 °C	2.5	Α	
l	Non repetitive surge peak on-state current (full cycle,	t = 8.3 ms	33		
I _{TSM}	T_j initial = 25 °C)	t = 10 ms	30	Α	
I ² t	I ² t value for fusing	t _p = 10 ms	9	A^2s	
dl/dt	Critical rate of rise of on-state current, $I_G = 2 \times I_{GT}$, tr \leq 100 ns, f = 60 Hz		50	A/µs	
V _{DRM} /V _{RRM}	Repetitive peak off-state voltage T _j = 125 °C		600	V	
V _{DSM} /V _{RSM}	Non Repetitive peak off-state voltage, 10 ms	750	V		
I _{GM}	Maximum peak gate current		1.2	А	
P _{GM}	Maximum gate power dissipation $t_p = 20 \mu s$, $T_j = 125 ^{\circ} C$		0.5	W	
T _{stg}	Storage temperature range	-40 to +125	°C		
Tj	Operating junction temperature range	-40 to +125	°C		
TL	Maximum lead temperature for soldering during 10 s	260	°C		

Table 2. Electrical characteristics (T_j = 25 °C, unless otherwise specified)

Symbol	Test conditions			Value	Unit
I _{GT} ⁽¹⁾			Min.	20	μΑ
'GT'	$V_D = 12 \text{ V}, R_L = 140 \Omega$		Max.	50	μΑ
V _{GT}				0.8	V
V_{GD}	$V_D = V_{DRM}$, $R_L = 3.3 \text{ k}\Omega$ $T_j = 125 ^{\circ}\text{C}$		Min.	0.1	V
V _{RGM}	I _{RG} = 10 μA		Max.	8	V
IL	$I_{G} = 1.2 \times I_{GT}$		Max.	6	mA
I _H ⁽²⁾	I _T = 500 mA, gate open		Max.	5	mA
dV/dt (2)	$V_D = 67 \% V_{DRM}, R_{GK} = 1 k\Omega$	T _j = 110 °C	Min.	15	V/µs

^{1.} For both polarities of OUT pin referenced to COM pin.

Table 3. Static characteristics

Symbol	Test conditions	Tj		Value	Unit
V _{TM} ⁽¹⁾	I _{TM} = 8 A, t _p = 380 μs	25 °C	Max.	1.8	V
V _{TO} ⁽¹⁾	Threshold voltage	125 °C	Max.	0.85	V
R _D ⁽¹⁾	Dynamic resistance	125 °C	Max.	100	mΩ
I_{DRM}/I_{RRM} $V_D = V_{DRM}$; $V_R = V_{RRM}$; $R_{GK} = 1 \text{ k}\Omega$	V V V V P 1 k0	25 °C	Max.	5	μΑ
	125°C	ividX.	1	mA	

1. For both polarities of A2 referenced to A1.

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^{2.} For both polarities of A2 referenced to A1.



Table 4. Thermal resistance

Symbol	Parameter	Value	Unit	
R _{th(j-c)}	Junction to case (DC)	Max.	3	°C/W
R _{th(j-a)}	Junction to ambient	Тур.	70	°C/W

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1.1 Characteristics (curves)

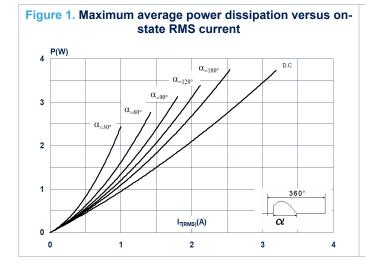
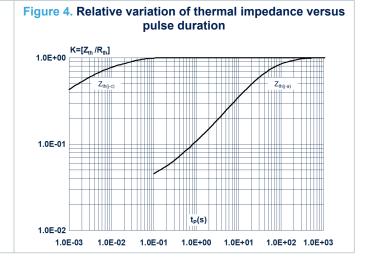
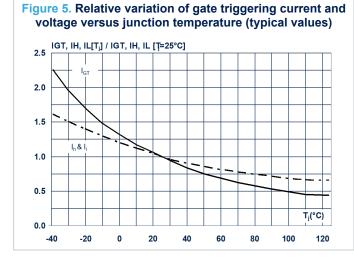
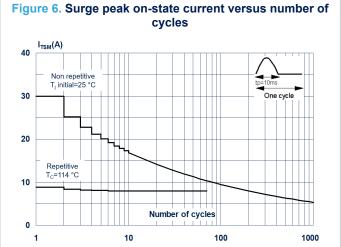


Figure 3. On-state RMS current versus ambient temperature (full cycle) I_{T(RMS)}(A) 2.0 1.5 1.0 0.5 T_a(°C) 0.0 25 75 0 50 100 125 150







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Figure 7. Non repetitive surge peak on-state current for a sinusoidal pulse with width $t_{\rm p}$ < 10 ms and corresponding value of l^2t

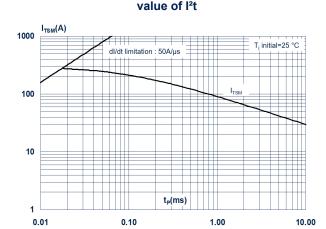


Figure 8. On-state characteristics (maximum values)

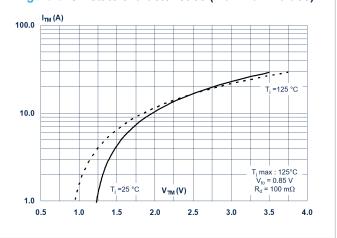


Figure 9. Relative variation of static dV/dt immunity versus gate-to-cathode resistance (typical values)

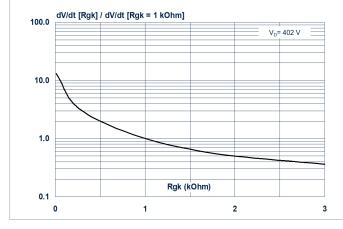


Figure 10. Relative variation of static dV/dt immunity versus gate-to-cathode capacitance (typical values)

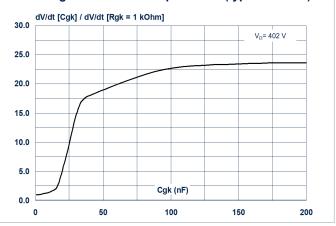
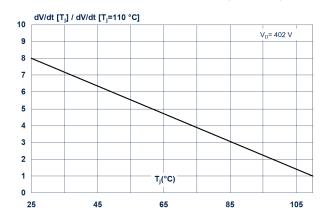


Figure 11. Relative variation of static dV/dt immunity versus junction temperature



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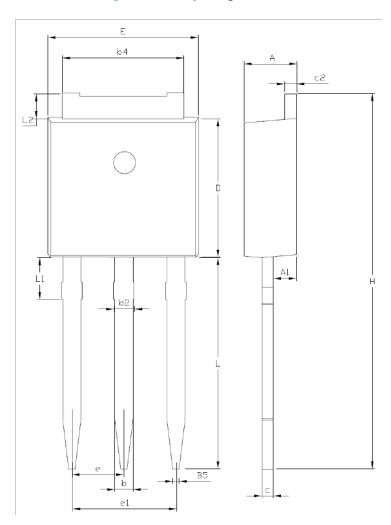
2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

2.1 IPAK package information

- Molding compouned resin is halogen free and meets UL94 flammability standard, level V0
- · Lead-free package leads plating

Figure 12. IPAK package outline



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Table 5. IPAK package mechanical data

	Dimensions					
Ref.	MillimetersInches (for reference only)					
	Min.	Тур.	Max.	Min.	Тур.	Max.
А	2.20		2.40	0.086		0.094
A1	0.90		1.10			0.035
b	0.64		0.90	0.025		0.035
b2			0.95			0.037
b4	5.20		5.43			
B5		0.30			0.012	
С	0.45		0.60			
c2	0.46		0.60			
D	6		6.20			
E	6.40		6.65	0.252		0.262
е		2.28			0.090	
e1	4.40		4.60	0.173		0.181
Н		16.10			0.634	
L	9		9.60	0.354		0.377
L1	0.8		1.20	0.031		0.047
L2		0.80	1.25		0.031	0.049
V1		10°			10°	

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3 Ordering information

Figure 13. Ordering information scheme

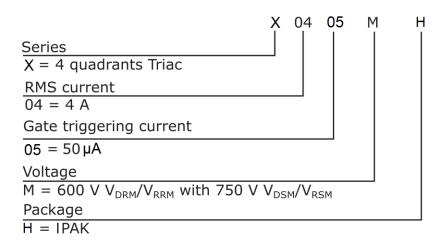


Table 6. Ordering information

Order code	Marking	Package	Weight	Base qty.	Delivery mode
X0405MH	X0405MH	IPAK	0.31 g	75	Tube

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Revision history

Table 7. Document revision history

Date	Revision	Changes
06-Sep-2022	1	Initial release.

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